ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	© Co	pyright 2005. IPC, Bannocl nternational and Pan-Americ	kburn, Illinois	. All rights reserve	ion with lower	level p	oarts, the	declaratio	n encom	npasses all l		erials for	which t	e item is an assembly he manufacturer has declaration.		
1752-2 1.1		Web Site for Informat ://www.ipc.org/IPC-1		-1752 Standar	d		n Type * ribute			aration Class * s 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Supplier Information																
Company Name * Anaren Microwave		Company Unique ID		Unique ID Aut	hority	Respo 2019-	onse Date 12-18) *	ſ	Response D	ocument ID					
Contact Name * Herbert Jones		Title - Contact Project Engineer		Phone - Cont 315-233-5510	Email - Contact * herbert.jones@ttm.com			n	Duplicate Contact -> Authorized Representative							
Authorized Represent	ative *	Title - Representative Project Engineer	9	Phone - Repr 315-233-5510				entative ettm.con		Supplier Cor	nments or UR	L for Add	ditional I	nformation		
Requester Item Num	ber	Mfr Item Number		Mfr Item Name		Effectiv	ve Date	Version	Manufa	cturing Site	Weight *	UC	DM	Unit Type		
		C45N50Z4		Termination	2019-7	2019-12-18 A East S			/racuse	0.024121	g		Each			
Alternate Recommen	dation						Alternate Item Cor			mments						
Manufacturing Proc																
Terminal Plating / Grid Array Material Terminal B Matte Tin (Sn) - with Nickel (Ni) barrier Other Comments Other				ase Alloy	J-STD-020 MSL Ra 1	ating	Peak Process Body Temperature Max Time at Pe 260 C					ak Temperature Number of Reflow Cycles 30 seconds 3				

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent changes	Lock Supplier Fields				
RoHS Material Con	mposition Declarat	ion				Declaration Type *	Custom				
RoHS Directive 2002/95/ECRoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) of homogeneous material for Cadmium											
RoHS 2 (Directive 2011/65/EU (DIBP).	& 2015/863/EU) Definition Add	dendum: Quantity limit of 0.1% by ma	ass (1000 PPM) in homog	eneous material for: Bis(2-ethy	ihexyl) phthalate (DEHP), Butyl	benzyl phthalate (BBP), Dibutyl phthala	ate (DBP), Diisobutyl phthalate				
date that Supplier completes the Supplier may have relied on in Supplier agrees that, at a mining	his form. Supplier acknowledge formation provided by others in mum, its suppliers have provide t to the identified part, the terms	es that Company will rely on this cert completing this form, and that Supp ed certifications regarding their contri and conditions of that agreement, ir	ification in determining the lier may not have indepen ibutions to the part, and th	e compliance of its products wit dently verified such information ose certifications are at least a	h European Union member stat n. However, in situations where s comprehensive as the certifica	ion is true and correct to the best of its k te laws that implement the RoHS Directi e Supplier has not independently verified ation in this paragraph. If the Company the sole and exclusive source of the Sup	ve. Company acknowledges that I information provided by others, and the Supplier enter into a				
RoHS Declaration *	1 - Item(s) does not contain	RoHS restricted substances per th	e definition above			Supplier Acceptance * Acce	pted				
Exemptions: If the declar above and choose all app		in RoHS restricted substance	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding respor	nse in the RoHS Declaration				
Declaration Signa	ture										
-	-	ields on all pages of this f and click on Submit Form				own. This will display the sig	nature area. Digitally sign				
Supplier Digital Signat	ture										

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	ltem/Subitem Name		Homogeneous Material	Weight	Unit of Measure			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Toler	ance +	PPM
+ -	C45N50Z4	+M -M	Substrate	0.02123	3g	+C	-C	Supplier	Substrate	+S	-s	Aluminum Nitride (ALN	24304-00-5		0.020171	g			950,00
						+C	-C	Supplier	Substrate	+S	-s	Yttrium (III) oxide (Y2O3	1314-36-9		0.001061	g			50,000
		+M -M	Conductor	0.00076	1g	+C	-C	Supplier	Conductor	+S	-s	Silver (Ag)	7440-22-4		0.000692	g			910,00
						+C	-C	Supplier	Conductor	+S	-s	Cobalt (Co)	7440-48-4		0.000011	g			15,000
						+C	-C	Supplier	Conductor	+S	-S	Titanium (Ti)	7440-32-6		0.000057	g			75,000
		+M -M	Thick Film Resis	0.00028	1g	+C	-C	Supplier	Thick Film Resistor	+S	-S	Boron Oxide (BO)	1303-86-2		0.000037	g			134,60
			-			+C	-C	Supplier	Thick Film Resistor	+S	-S	Magnesium Oxide (MgO	1309-48-4		0.000027	g			96,200
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Aluminum Oxide (Al2O3	1344-28-1		0.000037	g			134,60
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Silicon Dioxide (SiO2)	14808-60-7		0.000014	g			51,300
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Ruthenium(IV) dioxide (12036-10-1		0.000139	g			493,60
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Zinc oxide (ZnO)	1314-13-2		0.000025	g			89,700
		+M -M	Protective Glaze	0.00038	2g	+C	-C	Supplier	Protective Glaze	+S	-S	Boron Oxide (BO)	1303-86-2		0.000082	g			214,30
						+C	-C	Supplier	Protective Glaze	+S	-S	Aluminum Oxide (Al2O3	1344-28-1		0.000024	g			64,300
						+C	-C	Supplier	Protective Glaze	+S	-S	Silicon Dioxide (SiO2)	14808-60-7		0.000024	g			64,300
						+C	-C	Supplier	Protective Glaze	+S	-S	Chromium(III) oxide (Cr	1308-38-9		0.000005	g			14,200
						+C	-C	Supplier	Protective Glaze	+S	-S	Zinc oxide (ZnO)	1314-13-2		0.000245	g			642,90
		+M -M	Protective Polyn	n0.00068	3g	+C	-C	Supplier	Protective Polymer	+S	-S	*Proprietary Metal Com	Proprietary		0.000068	g			100,00
						+C	-C	Supplier	Protective Polymer	+S	-S	*Proprietary Blue Pigme	Proprietary		0.000136	g			200,00
						+C	-C	Supplier	Protective Polymer	+S	-S	Cobalt (Co)	7440-48-4		0.000204	g			300,00
			-	1		+C	-C	Supplier	Protective Polymer	+S	-S	Molybdenum (Mo)	7439-98-7		0.000273	g			400,00
		+M -M	Part Marking Ink	0.00000	6g	+C	-C	Supplier	Part Marking Ink	+S	-S	Titanium dioxide (TiO2)	13463-67-7		0.000005	g			857,10
				1	,			Supplier	Part Marking Ink	+S	-s	Silica amorphous (SiO2	7631-86-9	 	0.00000	g			142,90
		+M -M	Nickel Plating	0.00060	4g	+C	-C	Α	Lead/Lead Compound	+S	-S	Lead	7439-92-1		0.00000	g			499.75

		+С -С в	Nickel (external applic	+S -S	Nickel	7440-02-0	0.000604g	1	999,50
+M -M Tin Plating	0.000167g	+C -C Supplier	Tin Plating	+S -S	Tin (Sn)	7440-31-5	0.000167g		1,000,0